SIST

SLOVENSKI STANDARD
SIST EN 60249-2-2:1997

01-avgust-1997

Base materials for printed circuits - Part 2: Specifications - Specification No.2: Phenolic cellulose paper copper-clad laminated sheet, economic quality (IEC 249-2 -2:1985 + A2:1990)

Base materials for printed circuits -- Part 2: Specifications -- Specification No. 2: Phenolic cellulose paper copper-clad laminated sheet, economic quality

Basismaterialien für gedruckte Schaltungen -- Teil 2: Einzelbestimmungen -- Einzelbestimmung Nr. 2: Kupferkaschierte Phenolharz-Hartpapiertafeln, wirtschaftliche Qualität

iTeh STANDARD PREVIEW
(standards.iteh.ai)
SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/6f6730c7-c211-4217-a086-
22c4dd7ac077/sist-en-60249-2-2-1997

Matériaux de base pour circuits imprimés -- Partie 2: Spécifications -- Spécification n° 2: Feuille de papier cellulose phénolique recouverte de cuivre de qualité économique

Ta slovenski standard je istoveten z: **EN 60249-2-2:1994**

ICS:

31.180	Tiskana vezja (TIV) in tiskane plošče	Printed circuits and boards

SIST EN 60249-2-2:1997 **en**

2003-01.Slovenski inštitut za standardizacijo. Razmnoževanje celote ali delov tega standarda ni dovoljeno.

SIST EN 60249-2-2:1997

iTeh STANDARD PREVIEW
(standards.iteh.ai)

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

SIST EN 60249-2-2:1997

EUROPEAN STANDARD

NORME EUROPEENNE

EUROPÄISCHE NORM

EN 60249-2-2

February 1994

UDC 621.3.049.75-036

Supersedes HD 313.2.2 S3:1992

Descriptors: Printed board, base material, specification, phenolic paper

ENGLISH VERSION

Base materials for printed circuits
Part 2: Specifications
Specification No. 2: Phenolic cellulose paper copper-clad laminated sheet, economic quality
(IEC 249-2-2:1985 + A2:1990)

Matériaux de base pour circuits imprimés
Partie 2: Spécifications
Spécification n° 2: Feuille de papier cellulose phénolique recouverte de cuivre de qualité économique
(CEI 249-2-2:1985 + A2:1990)

Basismaterialien für gedruckte Schaltungen
Teil 2: Einzelbestimmungen
Einzelbestimmung Nr. 2: Kupferkaschierte Phenolharz-Hartpapiertafeln, wirtschaftliche Qualität
(IEC 249-2-2:1985 + A2:1990)

iTeh STANDARD PREVIEW
(standards.iteh.ai)
SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/.../sist-en-60249-2-2-1997

This European Standard was approved by CENELEC on 1993-12-08. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Denmark, Finland, France, Germany, Greece, Iceland, Ireland, Italy, Luxembourg, Netherlands, Norway, Portugal, Spain, Sweden, Switzerland and United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B-1050 Brussels

© 1994 Copyright reserved to CENELEC members

Ref. No. EN 60249-2-2:1994 E

SIST EN 60249-2-2:1997

FOREWORD

At the request of CENELEC 74th Technical Board, HD 313.2.2 S3:1992 (IEC 249-2-2:1985 + A2:1990 - including A1:1989) was submitted to the CENELEC voting procedure for conversion into a European Standard.

The text of the International Standard was approved by CENELEC as EN 60249-2-2 on 8 December 1993.

The following dates were fixed:

- latest date of publication of an identical national standard	(dop)	1995-03-15
- latest date of withdrawal of conflicting national standards	(dow)	-

Annexes designated "normative" are part of the body of the standard. In this standard, annex ZA is normative.

ENDORSEMENT NOTICE

iTeh STANDARD PREVIEW
(standards.iteh.ai)

The text of the International Standard IEC 249-2-2:1985 and its amendment 2:1990 (including A1:1989) was approved by CENELEC as a European Standard without any modification.

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

SIST EN 60249-2-2:1997

ANNEX ZA (normative)

OTHER INTERNATIONAL PUBLICATIONS QUOTED IN THIS STANDARD WITH THE REFERENCES OF THE RELEVANT EUROPEAN PUBLICATIONS

This European Standard incorporates by dated or undated reference, provisions from other publications. These normative references are cited at the appropriate places in the text and the publications are listed hereafter. For dated references, subsequent amendments to or revisions of any of these publications apply to this European Standard only when incorporated in it by amendment or revision. For undated references the latest edition of the publication referred to applies.

NOTE : When the international publication has been modified by CENELEC common modifications, indicated by (mod), the relevant EN/HD applies.

IEC Publication	Date	Title	EN/HD	Date
249-1	1982	Base materials for printed circuits Part 1: Test methods	EN 60249-1*	1993
249-3A	1976	Part 3: Special materials used in connection with printed circuits First supplement: Specification No. 2: Specification for copper foil for use in the manufacture of copper-clad base materials	-	-

iTeh STANDARD PREVIEW
(standards.iteh.ai)
SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

---

* EN 60249-1 includes A1:1984 + A2:1989 + A3:1991 to IEC 249-1

SIST EN 60249-2-2:1997

iTeh STANDARD PREVIEW
(standards.iteh.ai)

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

SIST EN 60249-2-2:1997

Ing. Mlakar France

COMMISSION ÉLECTROTECHNIQUE INTERNATIONALE

NORME DE LA CEI

INTERNATIONAL ELECTROTECHNICAL COMMISSION

IEC STANDARD

Publication 249-2-2

Deuxième édition — Second edition

1985

Matériaux de base pour circuits imprimés

Deuxième partie: Spécifications

Spécification n° 2: Feuille de papier cellulose phénolique recouverte de cuivre de qualité économique

iTeh STANDARD PREVIEW
(standards.iteh.ai)

Base materials for printed circuits

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

Part 2: Specifications

Specification No. 2: Phenolic cellulose paper copper-clad laminated sheet, economic quality

© CEI 1985

Droits de reproduction réservés — Copyright - all rights reserved

Bureau Central de la Commission Electrotechnique Internationale

3, rue de Varembé

Genève, Suisse

SIST EN 60249-2-2:1997

CONTENTS

iTeh STANDARD PREVIEW
(standards.iteh.ai)
SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21f-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

SIST EN 60249-2-2:1997

INTERNATIONAL ELECTROTECHNICAL COMMISSION

BASE MATERIALS FOR PRINTED CIRCUITS

Part 2: Specifications

Specification No. 2: Phenolic cellulose paper copper-clad laminated sheet, economic quality

FOREWORD

1) The formal decisions or agreements of the I E C on technical matters, prepared by Technical Committees on which all the National Committees having a special interest therein are represented, express, as nearly as possible, an international consensus of opinion on the subjects dealt with.
2) They have the form of recommendations for international use and they are accepted by the National Committees in that sense.
3) In order to promote international unification, the I E C expresses the wish that all National Committees should adopt the text of the I E C recommendation for their national rules in so far as national conditions will permit. Any divergence between the I E C recommendation and the corresponding national rules should, as far as possible, be clearly indicated in the latter.
4) The I E C has not laid down any procedure concerning marking as an indication of approval and has no responsibility when an item of equipment is declared to comply with one of its recommendations.

iTeh STANDARD PREVIEW
(standards.iteh.ai)

PREFACE

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750e7-e21f-4217-a986-2c3ef2d7ac67/sist-en-60249-2-2-1997

This standard has been prepared by I E C Technical Committee No. 52: Printed Circuits.

This second edition replaces the first edition of Specification No. 2 which was included in I E C Publication 249-2.

This standard forms Specification No. 2 of a publication series which will replace the specifications originally included in I E C Publication 249-2 and will also include new specifications.

The text of this standard is based on the following documents:

Six Months' Rule	Report on Voting
52(CO)237	52(CO)266

Further information can be found in the Report on Voting indicated in the table above.

The following I E C publications are quoted in this standard:

Publications Nos. 249-1 (1982): Base Materials for Printed Circuits, Part 1: Test Methods.
249-3A (1976): First Supplement to Publication 249-3 (1973): Metal-clad Base Materials for Printed Circuits. Part 3: Special Materials Used in Connection with Printed Circuits — Specification No. 2: Specification for Copper Foil for Use in the Manufacture of Copper-clad Base Materials.

SIST EN 60249-2-2:1997

BASE MATERIALS FOR PRINTED CIRCUITS

Part 2: Specifications

Specification No. 2: Phenolic cellulose paper copper-clad laminated sheet, economic quality

---

1. Scope

This specification gives requirements for properties of phenolic cellulose paper copper-clad laminated sheet, economic quality, in thicknesses of 0.5 mm up to 6.4 mm.

Note. — To designate this material, the reference: 249-2-2-IEC-PF-CP-Cu may be used; if there is no risk of confusion, the type designation may be abbreviated to read IEC-249-2-2.

2. Materials and construction

The sheet consists of an insulating base with metal foil bonded to one or both sides.

2.1 *Insulating base*

iTeh STANDARD PREVIEW
(standards.iteh.ai)

Phenolic resin bonded cellulose paper laminate.

2.2 *Metal foil*

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/816750c7-e211-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

Copper as specified in I E C Publication 249-3A: First Supplement to Publication 249-3: Metal-clad Base Materials for Printed Circuits, Part 3: Special Materials Used in Connection with Printed Circuits — Specification No. 2: Specification for Copper Foil for Use in the Manufacture of Copper-clad Base Materials.

The preferred foils are Type A (electro-deposited copper) of standard ductility.

3. Internal marking

Each sheet should bear a manufacturer's identification mark that is:

a) in black or some other colour not to be confused with red (red colour shall not be used as this indicates a material of defined flammability);

b) repeated at intervals so that no part of the sheet is further than 75 mm (3 in) from the furthest point of the nearest mark;

c) printed so as to indicate the machine direction of the filling material; if letters or numbers are used, these shall be upright in the machine direction.

Examples:

A	A	A	A	A
A	A	A	A	A
A	A	A	A	A
A	A	A	A	A
A	A	A	A	A

machine direction ↕

12	12	12	12	12
12	12	12	12	12
12	12	12	12	12
12	12	12	12	12
12	12	12	12	12

SIST EN 60249-2-2:1997

4. Electrical properties

TABLE I

Property	Test method (Sub-clause of I E C Publication 249-1) *	Requirement
Resistance of foil	2.1	As specified in I E C Publication 249-3A
Surface resistance after recovery	2.2	1 000 MΩ min.
Volume resistivity after recovery	2.3	100 MΩm min.
Surface resistance at 100 °C	2.9.1	30 MΩ min.
Volume resistivity at 100 °C	2.9.1	10 MΩm min.

* Base Materials for Printed Circuits, Part 1: Test Methods.

5. Non-electrical properties of the copper-clad sheet

iTeh STANDARD PREVIEW
(standards.iteh.ai)

5.1 *Appearance of the copper-clad face*

5.1.1 *Normal surface finish*

The copper-clad face shall be substantially free from blisters, wrinkles, pinholes, deep scratches, pits and resin. Any discoloration or contamination shall be readily removable with a hydrochloric acid solution of density 1.02 g/cm³ or with a suitable organic solvent.

SIST EN 60249-2-2:1997
https://standards.iteh.ai/catalog/standards/sist/8f6750c7-e21e-4217-a086-2c3ef2d7ac67/sist-en-60249-2-2-1997

5.1.2 *High-quality surface finish (optional)*

If a surface of high quality is essential for precious metal plating or fine line etching and is ordered by the purchaser the following requirements shall apply in addition to those of Sub-clause 5.1.1 when inspected in accordance with Sub-clause 3.9 of I E C Publication 249-1.

The surface finish of the copper-clad face shall be such as not to conceal imperfections.

The surface of the copper foil shall be free from scratches of depth greater than 0.010 mm (0.0004 in), or 1/5 of the nominal thickness of the copper foil, whichever is the lower.

The total length of scratches of depth greater than 0.005 mm (0.0002 in) but not greater than 0.010 mm (0.0004 in) shall not exceed 1 m per square metre (1 yd per square yard) of the total area of the sheet under test.

This requirement applies to the surface of 35 µm and 70 µm (305 g/m² and 610 g/m²—1 oz/ft² and 2 oz/ft²) foils. Permitted scratches on surfaces of 18 µm (152 g/m²—0.5 oz/ft²) foil are still under consideration.

The total area of all pinholes in an area of 0.5 m² (5.4 ft²) shall not exceed 0.012 mm² ($2 \cdot 10^{-5}$ in²).

No sheet shall have more imperfections of the types listed than those permitted by the following table: